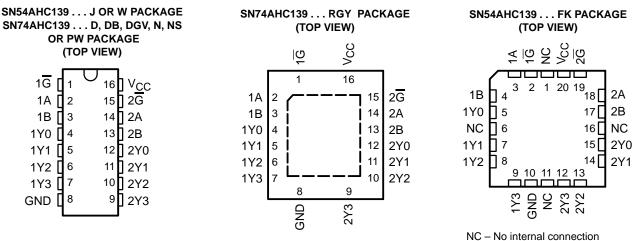
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- Operating Range 2-V to 5.5-V V<sub>CC</sub>
- Designed Specifically for High-Speed Memory Decoders and Data-Transmission Systems
- Incorporate Two Enable Inputs to Simplify Cascading and/or Data Reception
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22

   2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)



#### description/ordering information

The 'AHC139 devices are dual 2-line to 4-line decoders/demultiplexers designed for 2-V to 5.5-V V<sub>CC</sub> operation. These devices are designed to be used in high-performance memory-decoding or data-routing applications requiring very short propagation delay times. In high-performance memory systems, these decoders can be used to minimize the effects of system decoding. When used with high-speed memories utilizing a fast enable circuit, the delay times of these decoders and the enable time of the memory usually are less than the typical access time of the memory. This means that the effective system delay introduced by the decoders is negligible.

| TA             | PACKAGE <sup>†</sup>   |                | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |  |  |  |  |  |
|----------------|------------------------|----------------|--------------------------|---------------------|--|--|--|--|--|
|                | QFN – RGY              | Tape and reel  | SN74AHC139RGYR           | HA139               |  |  |  |  |  |
|                | PDIP – N               | DIP – N Tube S |                          | SN74AHC139N         |  |  |  |  |  |
|                | SOIC – D               | Tube           | SN74AHC139D              | AHC139              |  |  |  |  |  |
|                | 3010 - 0               | Tape and reel  | SN74AHC139DR             | And 139             |  |  |  |  |  |
| –40°C to 85°C  | SOP – NS Tape and reel |                | SN74AHC139NSR            | AHC139              |  |  |  |  |  |
|                | SSOP – DB              | Tape and reel  | SN74AHC139DBR            | HA139               |  |  |  |  |  |
|                | TSSOP – PW             | Tube           | SN74AHC139PW             | HA139               |  |  |  |  |  |
|                | 1330F - FW             | Tape and reel  | SN74AHC139PWR            | 11A139              |  |  |  |  |  |
|                | TVSOP – DGV            | Tape and reel  | SN74AHC139DGVR           | HA139               |  |  |  |  |  |
|                | CDIP – J               | Tube           | SNJ54AHC139J             | SNJ54AHC139J        |  |  |  |  |  |
| –55°C to 125°C | CFP – W                | Tube           | SNJ54AHC139W             | SNJ54AHC139W        |  |  |  |  |  |
|                | LCCC – FK Tube         |                | SNJ54AHC139FK            | SNJ54AHC139FK       |  |  |  |  |  |

#### **ORDERING INFORMATION**

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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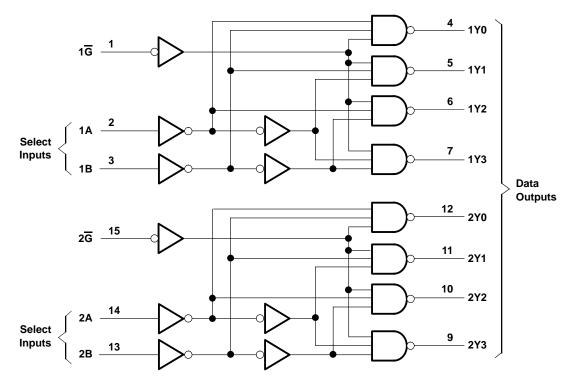
#### description/ordering information (continued)

The active-low enable ( $\overline{G}$ ) input can be used as a data line in demultiplexing applications. These decoders/demultiplexers feature fully buffered inputs, each of which represents only one normalized load to its driving circuit.

| (each decoder/demultiplexer) |        |     |    |      |      |    |  |  |  |
|------------------------------|--------|-----|----|------|------|----|--|--|--|
|                              | INPUTS |     |    | PUTS |      |    |  |  |  |
| G                            | SEL    | ECT |    | 001  | -015 |    |  |  |  |
| G                            | В      | Α   | Y0 | Y1   | Y2   | Y3 |  |  |  |
| Н                            | Х      | Х   | Н  | Н    | Н    | Н  |  |  |  |
| L                            | L      | L   | L  | Н    | н    | н  |  |  |  |
| L                            | L      | н   | н  | L    | н    | н  |  |  |  |
| L                            | н      | L   | н  | Н    | L    | н  |  |  |  |
| L                            | Н      | Н   | Н  | Н    | Н    | L  |  |  |  |

#### FUNCTION TABLE (each decoder/demultiplexe

### logic diagram (positive logic)



Pin numbers shown are for the D, DB, DGV, J, N, NS, PW, RGY, and W packages.



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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

3. The package thermal impedance is calculated in accordance with JESD 51-5.

#### recommended operating conditions (see Note 4)

|                |                                     |  | SN54A | HC139 | SN74A | HC139 |              |  |
|----------------|-------------------------------------|--|-------|-------|-------|-------|--------------|--|
|                |                                     |  | MIN   | MAX   | MIN   | MAX   | UNIT         |  |
| VCC            | Supply voltage                      |  | 2     | 5.5   | 2     | 5.5   | V            |  |
|                |                                     | V <sub>CC</sub> = 2 V                      | 1.5   |       | 1.5   |       |              |  |
| VIH            | High-level input voltage            | V <sub>CC</sub> = 3 V                      | 2.1   |       | 2.1   |       | V            |  |
|                |                                     | V <sub>CC</sub> = 5.5 V                    | 3.85  |       | 3.85  |       |              |  |
|                |                                     | V <sub>CC</sub> = 2 V                      |       | 0.5   |       | 0.5   |              |  |
| VIL            | Low-level input voltage             | V <sub>CC</sub> = 3 V                      |       | 0.9   |       | 0.9   | V            |  |
|                |                                     | V <sub>CC</sub> = 5.5 V                    |       | 1.65  |       | 1.65  |              |  |
| ٧ <sub>I</sub> | Input voltage                       | •  | 0     | 5.5   | 0     | 5.5   | V            |  |
| VO             | Output voltage                      |  | 0     | Vcc   | 0     | VCC   | V            |  |
|                |                                     | V <sub>CC</sub> = 2 V                      | 20    | -50   |       | -50   | μΑ           |  |
| ЮН             | High-level output current           | $V_{CC}$ = 3.3 V ± 0.3 V                   | 20    | -4    |       | -4    | mA           |  |
|                |                                     | $V_{CC}$ = 5 V ± 0.5 V                     |       | -8    |       | -8    |              |  |
|                |                                     | V <sub>CC</sub> = 2 V                      |       | 50    |       | 50    | μA           |  |
| IOL            | Low-level output current            | $V_{CC}$ = 3.3 V ± 0.3 V                   |       | 4     |       | 4     | A            |  |
|                |                                     | $V_{CC}$ = 5 V ± 0.5 V                     |       | 8     |       | 8     | mA           |  |
|                | Insuit transition rise or fell rate | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |       | 100   |       | 100   | <b>n</b> o// |  |
| Δt/Δv          | Input transition rise or fall rate  |  | 20    |       | 20    | ns/V  |              |  |
| TA             | Operating free-air temperature      | -  | -55   | 125   | -40   | 85    | °C           |  |

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED | TEST CONDITIONS                                    | Vaa          | T <sub>A</sub> = 25°C |     |      | SN54A | HC139 | SN74AHC139 |      | UNIT |
|-----------|--|--------------|-----------------------|-----|------|-------|-------|------------|------|------|
| PARAMETER | TEST CONDITIONS                                    | Vcc          | MIN                   | TYP | MAX  | MIN   | MAX   | MIN        | MAX  | UNIT |
|           |  | 2 V          | 1.9                   | 2   |      | 1.9   |       | 1.9        |      |      |
|           | I <sub>OH</sub> = -50 μA                           | 3 V          | 2.9                   | 3   |      | 2.9   |       | 2.9        |      |      |
| VOH       |  | 4.5 V        | 4.4                   | 4.5 |      | 4.4   |       | 4.4        |      | V    |
|           | I <sub>OH</sub> = -4 mA                            | 3 V          | 2.58                  |     |      | 2.48  | M:    | 2.48       |      |      |
|           | I <sub>OH</sub> = -8 mA                            | 4.5 V        | 3.94                  |     |      | 3.8   | N.    | 3.8        |      |      |
|           |  | 2 V          |                       |     | 0.1  | Č.    | 0.1   |            | 0.1  |      |
|           | I <sub>OL</sub> = 50 μA                            | 3 V          |                       |     | 0.1  | 40    | 0.1   |            | 0.1  |      |
| VOL       |  | 4.5 V        |                       |     | 0.1  | no    | 0.1   |            | 0.1  | V    |
|           | I <sub>OL</sub> = 4 mA                             | 3 V          |                       |     | 0.36 | PPO   | 0.5   |            | 0.44 |      |
|           | I <sub>OL</sub> = 8 mA                             | 4.5 V        |                       |     | 0.36 | Y     | 0.5   |            | 0.44 |      |
| lj        | V <sub>I</sub> = 5.5 V or GND                      | 0 V to 5.5 V |                       |     | ±0.1 |       | ±1*   |            | ±1   | μA   |
| ICC       | $V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$ | 5.5 V        |                       |     | 4    |       | 40    |            | 40   | μA   |
| Ci        | $V_{I} = V_{CC} \text{ or } GND$                   | 5 V          |                       | 2   | 10   |       |       |            | 10   | pF   |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested at  $V_{CC}$  = 0 V.

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM TO LOAD |          | Т                        | A = 25°C | ;                      | SN54AHC139 |     | SN74A | UNIT |      |      |      |     |
|------------------|--------------|----------|--------------------------|----------|------------------------|------------|-----|-------|------|------|------|------|-----|
| PARAMETER        | (INPUT)      | (OUTPUT) | CAPACITANCE              | MIN      | TYP                    | MAX        | MIN | MAX   | MIN  | MAX  | UNIT |      |     |
| <sup>t</sup> PLH | A or B       | Y        | Ci - 15 pE               |          | 7.2**                  | 11**       | 1** | 13**  | 1    | 13   | ns   |      |     |
| <sup>t</sup> PHL | AUB          | I        | C <sub>L</sub> = 15 pF   |          | 7.2**                  | 11**       | 1** | 13**  | 1    | 13   | 115  |      |     |
| <sup>t</sup> PLH | ы            | Y        | 0. 45 -5                 |          | 6.4**                  | 9.2**      | 1** | 11**  | 1    | 11   | 20   |      |     |
| <sup>t</sup> PHL | G            | T        | C <sub>L</sub> = 15 pF   |          | 6.4**                  | 9.2**      | 1** | 11**  | 1    | 11   | ns   |      |     |
| <sup>t</sup> PLH | A or B       | Y        | C <sub>I</sub> = 50 pF   |          | 9.7                    | 14.5       | 10  | 16.5  | 1    | 16.5 | ns   |      |     |
| <sup>t</sup> PHL | AUB          | Ι        | CL = 30 pr               |          | 9.7                    | 14.5       | 77  | 16.5  | 1    | 16.5 | 115  |      |     |
| <sup>t</sup> PLH | G            | Y        | $C_{\rm L} = 50  \rm pE$ |          | 8.9                    | 12.7       | × 1 | 14.5  | 1    | 14.5 | ns   |      |     |
| <sup>t</sup> PHL | 9            | T        | T                        |          | C <sub>L</sub> = 50 pF |            | 8.9 | 12.7  | 1    | 14.5 | 1    | 14.5 | 115 |

\*\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

| switching characteristics over recommended operating free-air temperature range, |
|--|
| $V_{CC}$ = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)                   |

| PARAMETER        | FROM    | то       | LOAD                     | T,         | <b>₄ = 25°C</b> | ;     | SN54A | HC139 | SN74A | HC139 | UNIT |     |
|------------------|---------|----------|--------------------------|------------|-----------------|-------|-------|-------|-------|-------|------|-----|
| PARAMETER        | (INPUT) | (OUTPUT) | CAPACITANCE              | MIN        | TYP             | MAX   | MIN   | MAX   | MIN   | MAX   | UNIT |     |
| <sup>t</sup> PLH | A or B  | Y        | C <sub>I</sub> = 15 pF   |            | 5**             | 7.2** | 1**   | 8.5** | 1     | 8.5   | ns   |     |
| <sup>t</sup> PHL | AUB     | 1        |                          | 0 <u> </u> |                 | 5**   | 7.2** | 1**   | 8.5** | 1     | 8.5  | 115 |
| <sup>t</sup> PLH | G       | Y        | C <sub>L</sub> = 15 pF   |            | 4.4**           | 6.3** | 1**   | 7.5** | 1     | 7.5   | ns   |     |
| <sup>t</sup> PHL | 9       | Ι        |                          |            | 4.4**           | 6.3** | 1**   | 7.5** | 1     | 7.5   | 115  |     |
| <sup>t</sup> PLH | A or B  | Y        | $C_{\rm L} = 50  \rm pE$ |            | 6.5             | 9.2   | 16    | 10.5  | 1     | 10.5  | ns   |     |
| <sup>t</sup> PHL | AUB     | I        | C <sub>L</sub> = 50 pF   |            | 6.5             | 9.2   | 20    | 10.5  | 1     | 10.5  | 115  |     |
| <sup>t</sup> PLH | G       | Y        | C <sub>L</sub> = 50 pF   |            | 5.9             | 8.3   | A 1   | 9.5   | 1     | 9.5   | nc   |     |
| <sup>t</sup> PHL | 9       |          | $C_{L} = 50 \text{ pr}$  |            | 5.9             | 8.3   | 1     | 9.5   | 1     | 9.5   | ns   |     |

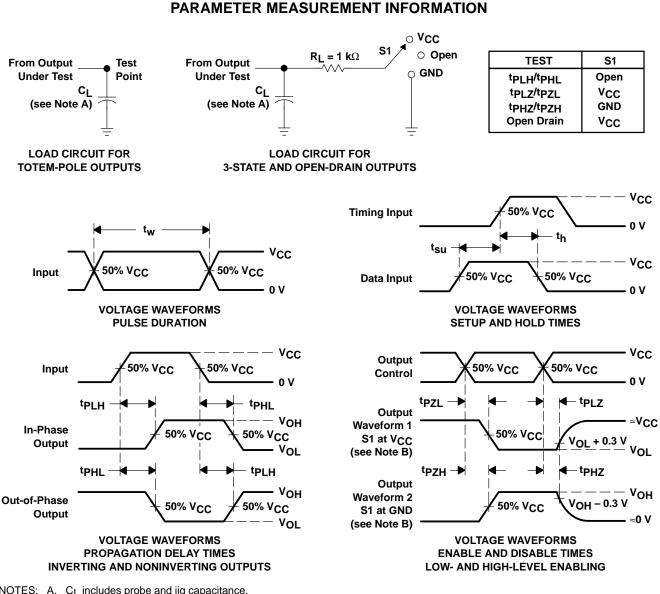
\*\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



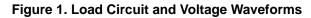
SCLS259K - DECEMBER 1995 - REVISED MARCH 2003

| ope | operating characteristics, V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C |          |           |     |      |  |  |  |  |  |
|-----|---|----------|-----------|-----|------|--|--|--|--|--|
|     | PARAMETER   | TEST CO  | ONDITIONS | TYP | UNIT |  |  |  |  |  |
| Cp  | d Power dissipation capacitance   | No load, | f = 1 MHz | 13  | рF   |  |  |  |  |  |



NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub>  $\leq$  3 ns, t<sub>f</sub>  $\leq$  3 ns.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.





9-Aug-2005

## **PACKAGING INFORMATION**

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| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| SN74AHC139D      | ACTIVE                | SOIC            | D                  | 16   | 40             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139DBLE   | OBSOLETE              | SSOP            | DB                 | 16   |                | TBD                       | Call TI          | Call TI                      |
| SN74AHC139DBR    | ACTIVE                | SSOP            | DB                 | 16   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139DBRE4  | ACTIVE                | SSOP            | DB                 | 16   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139DE4    | ACTIVE                | SOIC            | D                  | 16   | 40             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139DGVR   | ACTIVE                | TVSOP           | DGV                | 16   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139DGVRE4 | ACTIVE                | TVSOP           | DGV                | 16   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139DR     | ACTIVE                | SOIC            | D                  | 16   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139DRE4   | ACTIVE                | SOIC            | D                  | 16   | 2500           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139N      | ACTIVE                | PDIP            | Ν                  | 16   | 25             | Pb-Free<br>(RoHS)         | CU NIPDAU        | Level-NC-NC-NC               |
| SN74AHC139NE4    | ACTIVE                | PDIP            | Ν                  | 16   | 25             | Pb-Free<br>(RoHS)         | CU NIPDAU        | Level-NC-NC-NC               |
| SN74AHC139NSR    | ACTIVE                | SO              | NS                 | 16   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139NSRE4  | ACTIVE                | SO              | NS                 | 16   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139PW     | ACTIVE                | TSSOP           | PW                 | 16   | 90             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139PWG4   | ACTIVE                | TSSOP           | PW                 | 16   | 90             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139PWLE   | OBSOLETE              | TSSOP           | PW                 | 16   |                | TBD                       | Call TI          | Call TI                      |
| SN74AHC139PWR    | ACTIVE                | TSSOP           | PW                 | 16   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139PWRG4  | ACTIVE                | TSSOP           | PW                 | 16   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74AHC139RGYR   | ACTIVE                | QFN             | RGY                | 16   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1YEAR           |
| SN74AHC139RGYRG4 | ACTIVE                | QFN             | RGY                | 16   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-2-260C-1YEAR           |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements



for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



PLASTIC SMALL-OUTLINE

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

## DGV (R-PDSO-G\*\*)

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

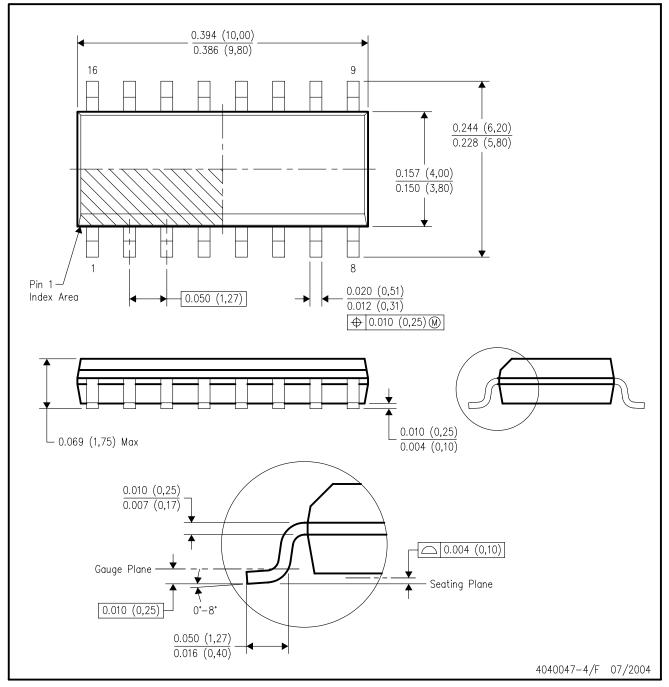
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



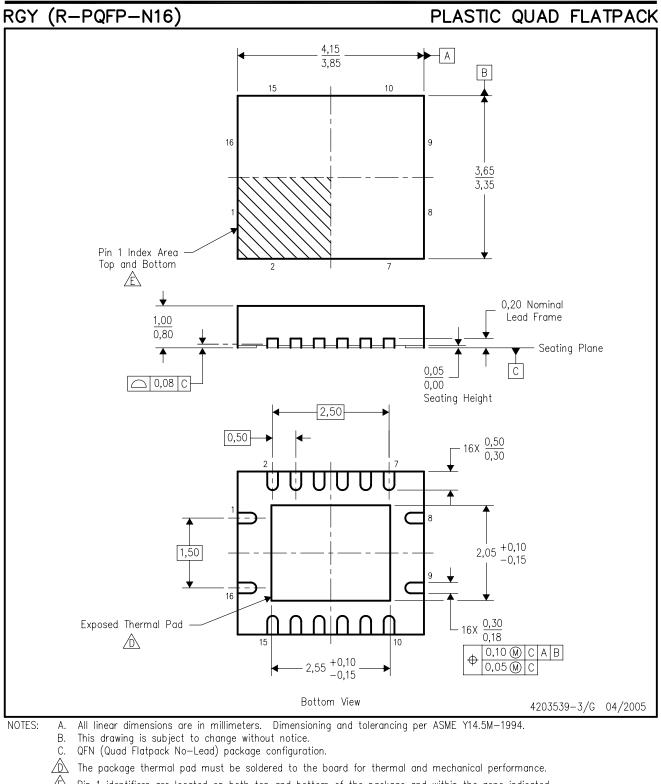
NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AC.





Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.

F. Package complies to JEDEC MO-241 variation BB.



### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

## DB (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

# PW (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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